

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Wayne Glenn Renken
Title: System and Method for Heating and Cooling Wafer at Accelerated Rates
Application No.: 10/619,731 Filing Date: July 15, 2003
Examiner: Rakesh K. DHINGRA Group Art Unit: 1763
Docket No.: SENS.007US1 Conf. No.: 7022

Mail Stop RCE
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

**TRANSMITTAL OF RCE AND REQUEST
FOR TWO-MONTH EXTENSION OF TIME**

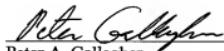
Sir:

Transmitted herewith are the following documents in the above-identified application:

- (1) This Transmittal Letter;
- (2) Request for Continued Examination (RCE) Transmittal;
- (3) Amendment Accompanying RCE and Statement of Interview (for which no claims fee is due).
 - Request is hereby made for a two-month extension of time to file these documents, up to and including May 19, 2006.

Please charge the RCE filing fee of \$395.00, the extension fee of \$225.00 (small entity), and any additional fees required, to Deposit Account No. 502664.

Respectfully submitted,


Peter A. Gallagher
Reg. No. 47,584

May 19, 2006
Date